Simplifying Solid-State Relay Designs With Logic

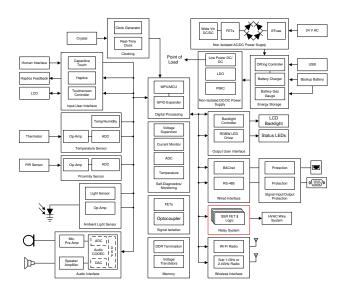


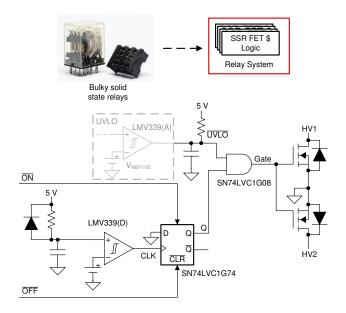
Analog applications have utilized mechanical relays to interface between higher voltage sub-systems and lower voltage control sub-systems. Historically, relay functionality has been implemented using electromechanical relays that are costly, large, bulky, and prone to wear over time, potentially leading to reliability issues. Solid-state relays are replacing traditional mechanical relays in many newer digital systems especially for smaller form factor applications such as smart thermostats and building control panels. Using simple building block IC circuits, designers can implement a solid-state relay that will eliminate electro-mechanical relay with a robust ICbased circuit solution. Simple logic devices can be used to help optimize and simplify solid-state relay implementations.

The solid-state relay control logic circuitry shown in the figure (right) uses simple logic devices such as the SN74LVC1G74 D-type flip-flop and the SN74LVC1G08 positive AND gate, to initiate the turn on and off the MOSFETs that are used in the solid-state relay implementation. Using simple logic ICs provide an efficient, robust, and cost-effective control circuit for a solid-state relay that can be implemented within applications such as thermostats, building HVAC control panels, or almost any other system where solid-state relays can be used to replace traditional mechanical relays. For more information on TI logic solutions, see www.ti.com/logic.

Device	Function
SN74LVC1G08	Single two-input AND gate
SN74LVC2G08	Dual two-input AND gate
SN74HCS08	Quad two-input AND gate
SN74LVC1G74	Single D flip-flop
SN74LVC2G79	Dual D flip-flop
SN74HCS74	Schmitt-trigger input dual D flip-flop







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